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**ON Semiconductor®** 

# FDBL86566-F085

# N-Channel PowerTrench<sup>®</sup> MOSFET 60 V, 240 A, 2.4 m $\Omega$

#### Features

- Typical  $R_{DS(on)}$  = 1.9 m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- Typical Q<sub>g(tot)</sub> = 80 nC at V<sub>GS</sub> = 10V, I<sub>D</sub> = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

### Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems

## **MOSFET Maximum Ratings** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Ratings	Units		
V <sub>DSS</sub>	Drain-to-Source Voltage		60	V	
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V	
I <sub>D</sub>	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	$T_C = 25^{\circ}C$	240	A	
	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	193	mJ	
P <sub>D</sub>	Power Dissipation		300	W	
	Derate Above 25°C		2.0	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.5	°C/W	
$R_{\thetaJA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W	

#### Notes:

- 1: Current is limited by silicon.
- 2: Starting  $T_J = 25^{\circ}$ C,  $L = 50 \mu$ H,  $I_{AS} = 88$ A,  $V_{DD} = 60$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche.

ROHS

3: R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design, while R<sub>0JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDBL86566	FDBL86566-F085	MO-299A	13"	24mm	2000 units

Symbol	Parameter	Test	Min.	Тур.	Max.	Units	
Off Cha	racteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		60	-	-	V
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> =60V,	$T_{J} = 25^{\circ}C$	-	-	1	μA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = 0V$ $T_J = 175^{\circ}C$ (Note 4) $V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I	= 250μA	2.0	3.2	4.0	V
	Drain to Source On Resistance	I <sub>D</sub> = 80A,	$T_J = 25^{\circ}C$	-	1.9	2.4	mΩ
*DS(on)		V <sub>GS</sub> = 10V	$T_{\rm J} = 175^{\rm o} {\rm C} \ ({\rm Note} \ 4)$	-	3.5	4.5	mΩ
Dynami	c Characteristics						
C <sub>iss</sub>	Input Capacitance			-	6655	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 30V, V_{DS} = 1000$	/ <sub>GS</sub> = 0V,	-	1745	-	pF
Crss	Reverse Transfer Capacitance	= T = 1MHz		-	57	-	pF
<u>२,</u>	Gate Resistance	f = 1MHz		-	2.2	-	Ω
	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V $V_{GS} = 30V$		-	80	110	nC
$Q_{a(th)}$	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 2^{10}$	$V I_D = 80A$	-	12	-	nC
$Q_{as}$	Gate-to-Source Gate Charge			-	35	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	10	-	nC
Switchi	ng Characteristics						
t <sub>on</sub>	Turn-On Time			-	-	86	ns
t <sub>d(on)</sub>	Turn-On Delay			-	37	-	ns
t <sub>r</sub>	Rise Time	$V_{DD}$ = 30V, I <sub>D</sub> = 80A, $V_{GS}$ = 10V, R <sub>GEN</sub> = 6 $\Omega$		-	29	-	ns
t <sub>d(off)</sub>	Turn-Off Delay			-	39	-	ns
f í	Fall Time				13	-	ns
off	Turn-Off Time			-	-	68	ns
Drain-S	ource Diode Characteristics						
Ven	Source-to-Drain Diode Voltage	I <sub>SD</sub> =80A, V <sub>GS</sub> = 0V		-	-	1.25	V
· 5D		I <sub>SD</sub> = 40A, V	/ <sub>GS</sub> = 0V	-	-	1.2	V
t <sub>rr</sub>	Reverse-Recovery Time	I <sub>F</sub> = 80A, dI <sub>SD</sub> /dt = 100A/μs, V <sub>DD</sub> =48V		-	78	102	ns
Q <sub>rr</sub>	Reverse-Recovery Charge			-	100	130	nC





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